

## SOT-323 Plastic-Encapsulate MOSFET N -Channel MOSFET

### Product Summary

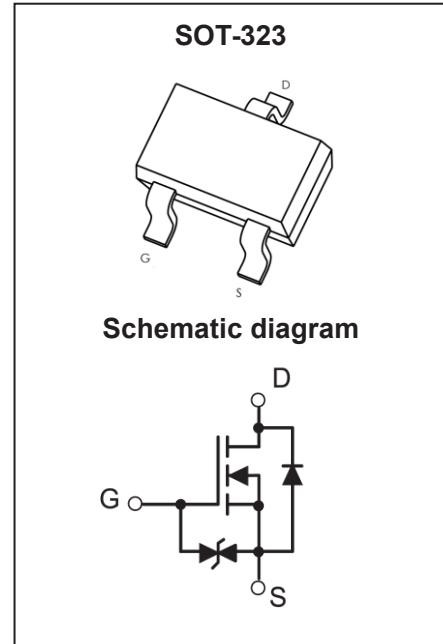
$V_{(BR)DSS}$	$R_{DS(on)TYP}$	$I_D$
20V	170mΩ@4.5V	0.75A
	230mΩ@2.5V	
	330mΩ@1.8V	

### Feature

- Trench Technology Power MOSFET
- Low  $R_{DS(ON)}$
- Low Gate Charge
- ESD Protected

### Application

- Load Switch
- DC/DC Converter



### MARKING:



### ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

Parameter		Symbol	Value	Unit
Drain - Source Voltage		$V_{DS}$	20	V
Gate - Source Voltage		$V_{GS}$	$\pm 12$	V
Continuous Drain Current <sup>1,5</sup>	$T_A = 25^\circ\text{C}$	$I_D$	0.75	A
Pulsed Drain Current <sup>2</sup>		$I_{DM}$	3.0	A
Power Dissipation <sup>4,5</sup>	$T_A = 25^\circ\text{C}$	$P_D$	200	mW
Thermal Resistance from Junction to Ambient <sup>5</sup>		$R_{\theta JA}$	625	°C/W
Junction Temperature		$T_J$	150	°C
Storage Temperature		$T_{STG}$	-55~ +150	°C

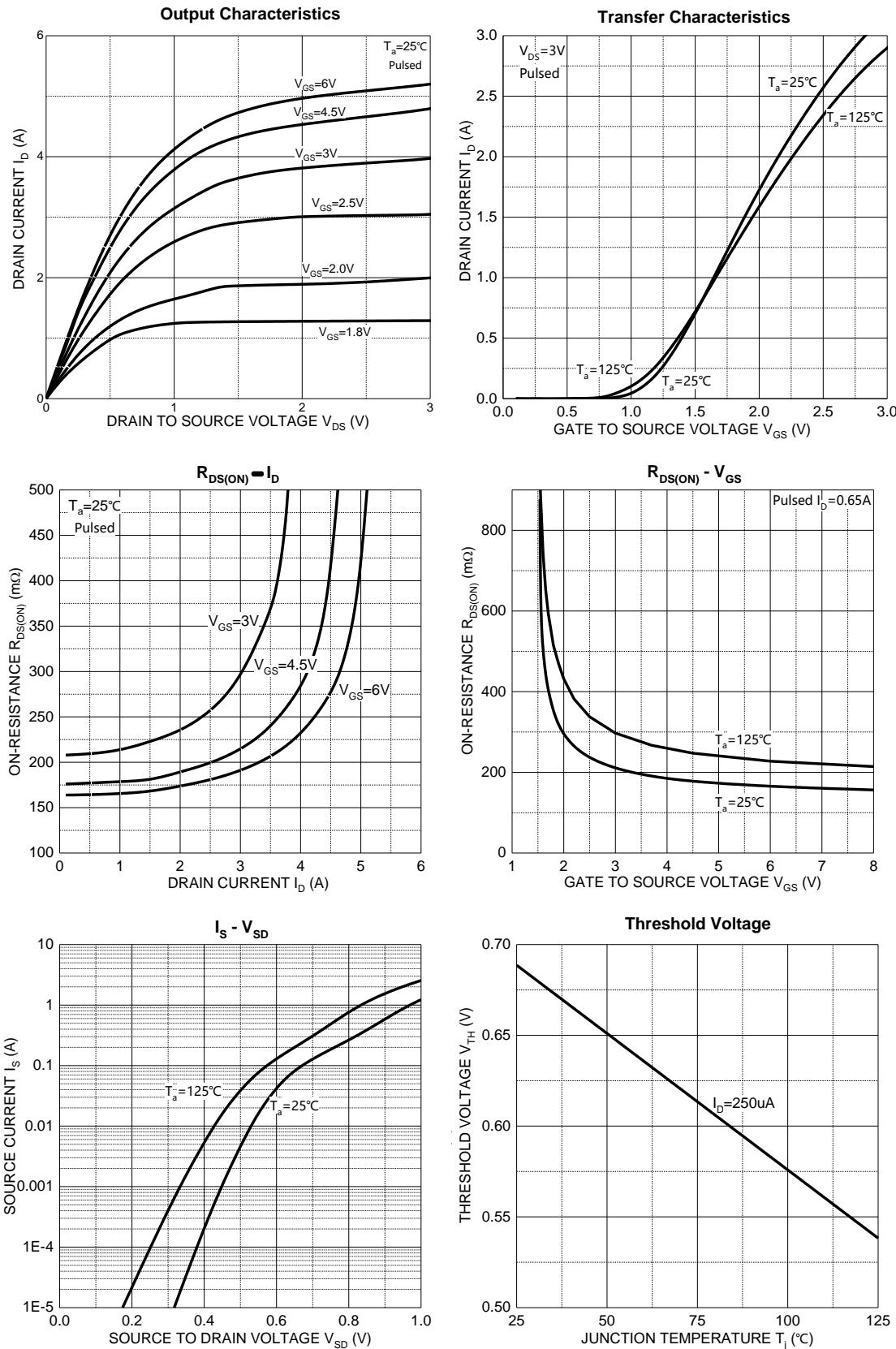
## Electrical Characteristics ( $T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Type	Max	Unit
<b>Off Characteristics</b>						
Drain - Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_D = 250\mu\text{A}$	20			V
Zero Gate Voltage Drain Current	$I_{\text{DSS}}$	$V_{\text{DS}} = 20\text{V}, V_{\text{GS}} = 0\text{V}$			1	$\mu\text{A}$
Gate - Body Leakage Current	$I_{\text{GSS}}$	$V_{\text{GS}} = \pm 10\text{V}, V_{\text{DS}} = 0\text{V}$			$\pm 10$	$\mu\text{A}$
<b>On Characteristics<sup>3</sup></b>						
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = 250\mu\text{A}$	0.4	0.7	1	V
Drain-source On-resistance	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}} = 4.5\text{V}, I_D = 0.65\text{A}$		170	380	$\text{m}\Omega$
		$V_{\text{GS}} = 2.5\text{V}, I_D = 0.55\text{A}$		230	450	
		$V_{\text{GS}} = 1.8\text{V}, I_D = 0.45\text{A}$		330	590	
<b>Dynamic Characteristics</b>						
Input Capacitance	$C_{\text{iss}}$	$V_{\text{DS}} = 10\text{V}, f = 1\text{MHz}$		55.6		$\text{pF}$
Output Capacitance	$C_{\text{oss}}$			15.2		
Reverse Transfer Capacitance	$C_{\text{rss}}$			10.3		
<b>Switching Characteristics</b>						
Total Gate Charge	$Q_g$	$V_{\text{DD}} = 10\text{V}, V_{\text{GS}} = 4.5\text{V}, I_D = 0.65\text{A}$		0.78		$\text{nC}$
Gate-source Charge	$Q_{\text{gs}}$			0.23		
Gate-drain Charge	$Q_{\text{gd}}$			0.01		
Turn-on Delay Time	$t_{\text{d}(\text{on})}$	$V_{\text{DS}} = 10\text{V}, V_{\text{GS}} = 4.5\text{V}$ $I_D = 0.5\text{A}, R_{\text{GEN}} = 10\Omega$		6.7		$\text{ns}$
Turn-on Rise Time	$t_r$			4.8		
Turn-off Delay Time	$t_{\text{d}(\text{off})}$			17.3		
Turn-off Fall Time	$t_f$			7.4		
<b>Source - Drain Diode Characteristics</b>						
Diode Forward Voltage <sup>3</sup>	$V_{\text{SD}}$	$V_{\text{GS}} = 0\text{V}, I_s = 0.15\text{A}$			1.2	V

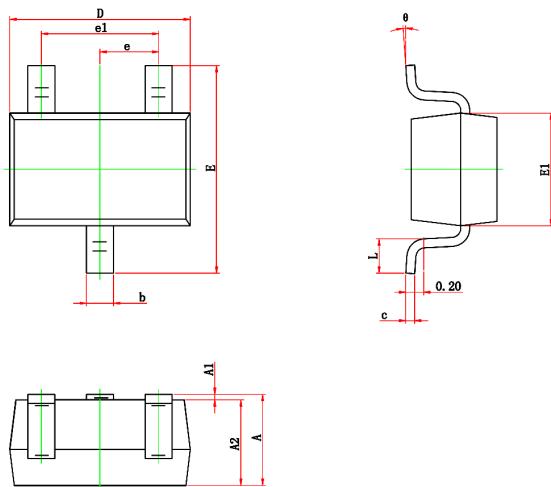
Notes :

- 1.The maximum current rating is limited by package.
- 2.Pulse Test : Pulse Width  $\leq 10\mu\text{s}$ , duty cycle  $\leq 1\%$ .
- 3.Pulse Test : Pulse Width  $\leq 300\mu\text{s}$ , duty cycle  $\leq 2\%$ .
- 4.The power dissipation  $P_D$  is limited by  $T_{\text{J}(\text{MAX})} = 150^\circ\text{C}$ .
- 5.Device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A = 25^\circ\text{C}$ .

## Typical Characteristics

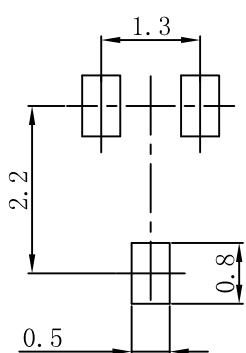


## SOT-323 Package Outline Dimensions



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.900	1.100	0.035	0.043
A1	0.000	0.100	0.000	0.004
A2	0.900	1.000	0.035	0.039
b	0.200	0.400	0.008	0.016
c	0.050	0.150	0.002	0.006
D	1.900	2.200	0.075	0.087
E	2.000	2.450	0.079	0.096
E1	1.150	1.350	0.045	0.053
e	0.650TYP.		0.026TYP.	
e1	1.200	1.400	0.047	0.055
L	0.200	0.460	0.008	0.018
θ	0°	8°	0°	8°

## SOT-323 Suggested Pad Layout



### Note:

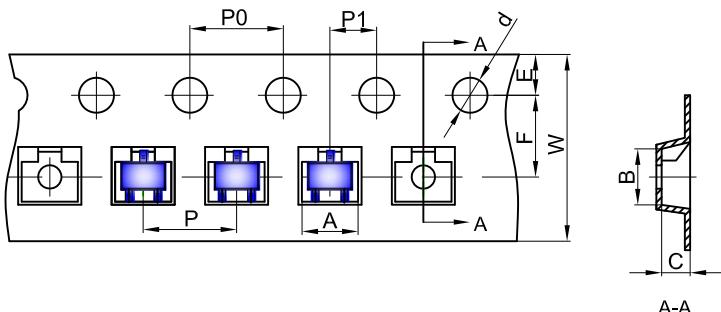
1. Controlling dimension:in millimeters.
2. General tolerance: $\pm 0.05$ mm.
3. The pad layout is for reference purposes only.

### NOTICE

JSHD reserve the right to make modifications,enhancements, improvements, corrections or other changes without further notice to any product herein .JSHD does not assume any liability arising out of the application or use of any product described herein.

# Reel Taping Specifications For Surface Mount Devices-SOT-323

## SOT-323 Embossed Carrier Tape

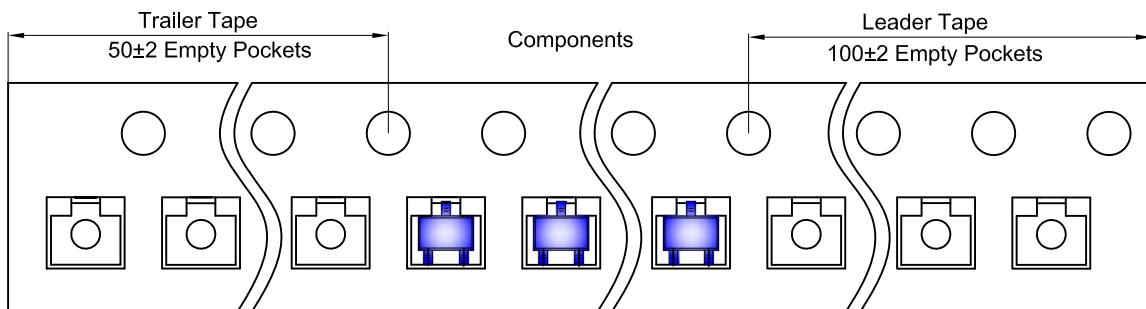


### Packaging Description:

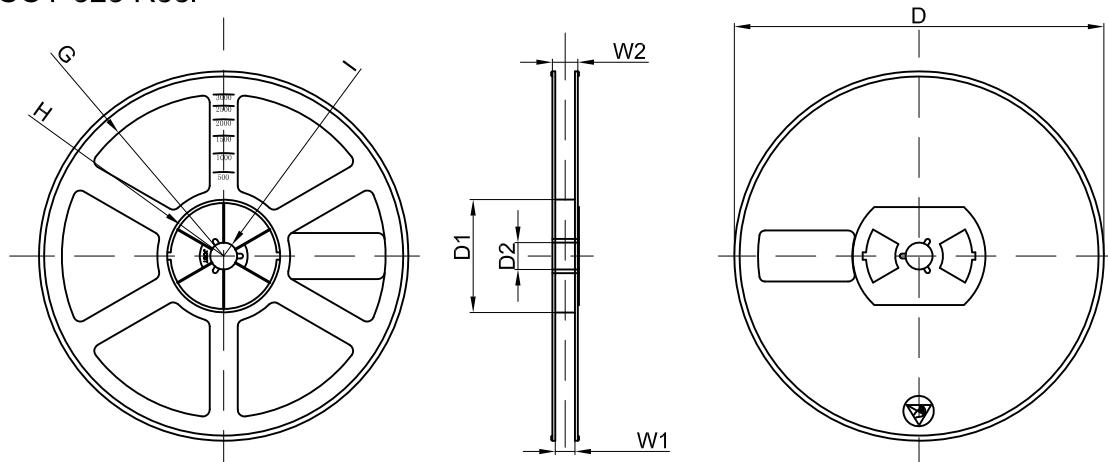
SOT-323 parts are shipped in tape. The carrier tape is made from a dissipative (carbon filled) polycarbonate resin. The cover tape is a multilayer film (Heat Activated Adhesive in nature) primarily composed of polyester film, adhesive layer, sealant, and anti-static sprayed agent. These reeled parts in standard option are shipped with 3,000 units per 7" or 17.8cm diameter reel. The reels are clear in color and is made of polystyrene plastic (anti-static coated).

Dimensions are in millimeter										
Pkg type	A	B	C	d	E	F	P0	P	P1	W
SOT-323	2.25	2.55	1.19	Ø1.55	1.75	3.50	4.00	4.00	2.00	8.00

## SOT-323 Tape Leader and Trailer



## SOT-323 Reel



Dimensions are in millimeter								
Reel Option	D	D1	D2	G	H	I	W1	W2
7" Dia	Ø178.00	54.40	13.00	R78.00	R25.60	R6.50	9.50	12.30

REEL	Reel Size	Box	Box Size(mm)	Carton	Carton Size(mm)	G.W.(kg)
3000 pcs	7 inch	45,000 pcs	203×203×195	180,000 pcs	438×438×220	